



### SINGLE CELL LINEAR LITHIUM BATTERY CHARGER WITH 28V OVP AND PROGRAMMABLE CHARGE TIMER

### Description

The APM8600 is a linear Li-Ion charger for portable equipment that is optimized for small form-factor applications.

The charge algorithm in the APM8600 covers all the charge requirements for a single Li-Ion battery cell. Included is precharging for deeply discharged cells, constant current / constant voltage fast charging and a top-off feature to bring the cell safely to a full-charge level.

The battery is constantly monitored for overvoltage, charge time and cell temperature to ensure safe charging. A fault is triggered once the charge time exceeds a value that is programmable using a single capacitor and the temperature measurement is achieved through a thermistor positioned close to the battery cell.

The APM8600 is packaged in U-DFN3030-14 package with a thermal pad.

### **Features**

- Linear Lithium Ion / Lithium Polymer Charging IC
- Supply Input Safe up to 28V
- Fast Charging with Maximum Current of 1A
- Resistor-Programmable Charging Current
- Resistor Programmable End-Of-Charge
- Capacitor Programmable Charge Timer
- Three Charge Indicator Pins for a Status Display
- Thermal Protection
- U-DFN3030-14: Available in "Green" Molding Compound
   (Na Da Ch)

(No Br, Sb)

- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  - 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

#### 14 FLT BAT 1 DC . 13 SETI 2 12 тнм DC 3 APM8600 11 CHG GND 4 POK 10 СТ 5 DNC 6 9 NC 8 NC

# Figure 1 Pin Out

Applications

**Pin Assignments** 

- Handheld Consumer Devices
- Cell Phones, PDAs, MP3 Players
- Handheld Test Equipment
- Digital Still Cameras
- Multimedia Players



# **Typical Application Circuit**





Name	Pin #	Description			
BAT	1, 7	Connection to the Battery	The battery is charged via this pin and the BAT voltage is constantly monitored. Connect a bypass capacitor between BAT and GND (2.2µF).		
SETI	2	Charge Current programming	The maximum charge current is programmed using a resistor from SETI to GND. This also determines the prequal current charging level and top-off threshold.		
ТНМ	3	Thermistor Input	To monitor the battery temperature, connect a $10k\Omega$ NTC thermistor. Place this thermistor as close as possible to the battery. Connect THM to GND if temperature measurement is not required.		
GND	4	Ground	Ground connection.		
СТ	5	Charge Timing	Connecting a capacitor from CT to GND will set the time-outs for prequal, top-off and fast-charge. Connecting CT direct to GND disables these timers.		
ĒN	8	Enable (Active-low)	The charger is enabled when this input is low. To start the charger connect $\overline{\text{EN}}$ to GND. Drive this input high to disable the charger.		
POK	10	Power OK (Active -low)	When a valid input source is connected, this open-drain output is pulled low.		
CHG	11	Charge Status (Active -low)	Open-drain output that indicates the charging status. It is active only in the fast- charge state and goes high-impedance when the charger is either disabled or in prequal or top-off mode.		
DC	12, 13	DC Input	DC supply input. The recommended input voltage is between 4.32V and 7V. This input is capable of withstanding up to 28V. Connect both DC pins together on the PCB. It is recommended to connect a bypass capacitor $(1\mu F)$ from DC to GND.		
FLT	14	Fault Flag (Active -low)	If the prequal or fast-charge timers expire and the charging threshold voltage is not reached, $\overline{FLT}$ (open-drain output) will go low. Remove the fault by cycling power or raise $\overline{EN}$ .		
	EP	Exposed Pad	For optimal thermal performance connect to copper on PCB (electrically this can be GND).		
NC	7,9	Not Connected	Floating pins		
NC	6	Do Not Connect	Must not connect		



# **Functional Block Diagram**





### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
-	DC to GND	-0.3 to 28V	V
_	BAT, CT, SETI, THM, FLT, CHG, POK, EN to GND	-0.3 to 6V	V
ESD Susceptibilit	y (Note 4)		
HBM	Human Body Model	2	kV
MM	Machine Model	200	V

e: 4. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should taken when handling and transporting this device.

### **Thermal Resistance (Note 5)**

Symbol	Parameter	Rating	Unit
θ <sub>JA</sub>	Junction to Ambient	40	°C/W

Note: 5. Test condition for DFN3030-10: Device mounted on FR-4 2-layer board, 2oz copper, with minimum recommended pad on top layer and 6 vias to bottom layer 1.0"x1.5" ground plane.

### **Recommended Operating Conditions (Note 6)**

Symbol	Parameter	Rating	Unit
_	Ambient Temperature Range	-40 to +85	°C
-	Input Supply Voltage	4.15 to 7.00	V
I <sub>CHARGE</sub>	Typical Charge Current	0.1 to 1.0	А

Note: 6. The device function is not guaranteed outside of the recommended operating conditions.





### **Electrical Characteristics**

APM8600 is tested at V<sub>DC</sub> = 5V, V<sub>BAT</sub> = 4V, V<sub>EN</sub> = 0V, R<sub>SETI</sub> = 2k $\Omega$ , C<sub>CT</sub> = 68nF, at an ambient temperature of +25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V <sub>DC</sub>	Input Voltage Range	-	0	-	28	V
V <sub>DC</sub>	Input Operating Range (Note 7)	-	4.15		7.00	V
UVLO	Input Undervoltage Lock Out (Note 7)	Input rising, 500mV hysteresis (typ.) V <sub>BAT</sub> = 3.2V	3.85	4.0	4.15	V
OVLO	Input Overvoltage Lock Out	Input rising, 200mV hysteresis (typ.)	7.2	7.5	7.8	V
I <sub>DC</sub>	Input Supply Current	$I_{BAT} = 0mA, R_{THM} = 10k\Omega$		750	1200	μA
I <sub>SHTDWN</sub>	Shutdown Current	$\overline{EN}$ = High, T <sub>A</sub> = +25°C	-	275	435	μA
R <sub>DS_ON</sub>	Input to BAT On-Resistance	Input = 3.7V, V <sub>BAT</sub> = 3.6V		0.5	0.8	Ω
V <sub>DROPOUT</sub>	Input to BAT dropout Voltage	Input falling, 200mV hysteresis (typ.)	5	55	150	mV
$V_{BAT\_REG}$	Battery Voltage Regulation	I <sub>BAT</sub> = 0mA, T <sub>A</sub> = +25°C	4.179	4.2	4.221	V
BAT <sub>RSTTH</sub>	Battery Fast-Charge Restart Threshold	From BAT regulation voltage	-230	-175	-110	mV
		R <sub>SETI</sub> = 1.5kΩ	950	1000	1140	
IDC CHG	DC Charge Current	$R_{SETI} = 2.0 k\Omega$	727	750	870	mA
IDC_CHG	V <sub>USB</sub> = 0V	R <sub>SETI</sub> = 5.0kΩ	280	300	353	
		Prequal, $R_{SETI} = 2k\Omega$ , $V_{BAT} = 2.5V$	60	75	95	
SS	Soft-Start Time	Ramp time to fast-charge	Ι	1.2	Ι	ms
V <sub>PREQ_TH</sub>	BAT Prequel Threshold	V <sub>BAT</sub> rising, 180mV hysteresis (typ.)	2.9	3.0	3.1	V
I <sub>LEAK</sub>	BAT Leakage Current	$V_{DC} = V_{USB} = 0V, V_{BAT} = 4.2V$	1	0.001	5	μA
R <sub>SETI</sub>	Resistance Range for SETI	Guaranteed by charging current	1.5	-	5.0	kΩ

Note: 7. Guaranteed by testing of undervoltage- and overvoltage-threshold. To completely charge a battery cell, the input voltage must be greater than 4.32V.





### **Electrical Characteristics (Cont.)**

APM8600 is tested at  $V_{DC}$  = 5V,  $V_{BAT}$  = 4V,  $V_{\overline{EN}}$  = 0V,  $R_{SETI}$  = 2k $\Omega$ ,  $C_{CT}$  = 68nF, at an ambient temperature of +25°C unless otherwise noted.

	ogic Output Voltage, Low	Rising       Falling $V_{EN} = 0$ to 5.5V, $T_A = 25^{\circ}C$ $I_{POK} = I_{CHG} = I_{PLT} = 1mA$	- 0.4 -		1.6 - 1	V µA
	ogic Input Leakage Current T ogic Output Voltage, Low	Falling $V_{\overline{EN}} = 0$ to 5.5V, $T_A = 25^{\circ}C$		- 0.001	-	-
	ogic Input Leakage Current T ogic Output Voltage, Low	$V_{EN} = 0$ to 5.5V, $T_A = 25^{\circ}C$	0.4	- 0.001	- 1	-
	ogic Output Voltage, Low	$T_A = 25^{\circ}C$		0.001	1	μA
Lc	ogic Output Voltage, Low	$I_{\overline{POK}} = I_{\overline{CHG}} = I_{\overline{PLT}} = 1\text{mA}$	$\frown$			
_		$I_{\overline{POK}} = I_{\overline{CHG}} = I_{\overline{FLT}} = 1mA$				
- Lo			-/	12	100	mV
Hi	ogic Output Leakage Current, ligh	$V_{POK} = V_{CHG} = V_{RT} = 5.5V$ $V_{DC} = V_{USB} = 0V$ $T_A = +25^{\circ}C$	-	0.001	1	μA
	CHG / Top-Off Threshold	$\begin{array}{l l} I_{BAT} \text{ falling,} & R_{SETI} = 1.5 k\Omega \\ \text{battery is} & R_{SETI} = 2.0 k\Omega \\ \text{charged} & R_{SETI} = 5.0 k\Omega \end{array}$	- 37.5 -	75 56.25 22.5	_ 75 _	mA
R <sub>THM_Pullup</sub> In	nternal Pullup Resistance	-	5	10	-	kΩ
Tł	HM Resistance, Hot	R <sub>THM</sub> falling, 420Ω hyst. (typ.)	3.72	3.94	4.13	kΩ
R <sub>THM</sub> TH	HM Resistance, Cold	R <sub>THM</sub> rising, 2.7kΩ hyst. (typ.)	26.7	28.3	29.7	kΩ
Tł	HM Resistance, Disabled	R <sub>THM</sub> falling, 230Ω hyst. (typ.)	260	315	370	Ω
CT <sub>accu</sub> Cł	charge Timer Accuracy	C <sub>CT</sub> = 68nF	-20	-	+20	%
TL <sub>Prequal</sub> Pr	requal Time Limit	From entering prequal to $\overline{FLT}$ going low, $V_{BAT} < 3V$		34.8		min
TL <sub>CHG</sub> CI	Charge Time Limit	From entering fast-charge to FLT going low, 3V < V <sub>BAT</sub> < 4.2V	334			min
TL <sub>Top_off</sub> To	op-Off Time Limit	From CHG going high to charger disabled		34.8		min
	hermal Foldback Threshold emperature	Junction temperature beyond which the charge current is reduced, $T_J$ rising	+100			٥C
THFB <sub>Gain</sub> Th	hermal Foldback Gain	Reduction of $I_{BAT}$ for increase in T <sub>J</sub> (using V <sub>DC</sub> ), R <sub>SETI</sub> = 1.5kΩ		5		%/ºC



### **Functional Description**

APM8600 is a linear Li-lon battery charger device for single-cell applications. Charge currents can be programmed with the R<sub>SETI</sub> resistor. The device also incorporates several safety features, such as charge timers, battery temperature monitoring and internal thermal limiting.

### Functional State Diagram





### **Functional Description (Cont.)**

#### INPUTS

**DC** Pins 12 and 13 are the DC input. This input will allow charging from input voltages between 4.15V and 7V, and can withstand up to 28V without device damage although charging is disabled above 7.5V (typ.).

**GND** System ground connection.

**EN** Pin 8 is the enable pin of the device. When pulled low the device will operate normally. When high, the device will remain in the disabled state. For auto-starting, connect pin 8 directly to GND.

SETI Pin 2 allows the charge currents to be programmed.

$$RSETI = \frac{1500}{ICHARGE}$$

The charge current setting also changes the currents in prequal and top-off modes (being 10% and 7.5% of I<sub>CHARGE</sub> respectively):

 $\mathsf{ITOPOFF} = \frac{112.5}{\mathsf{RSET}}$ 

This pin can also be used to monitor the battery charging current:

Т

**THM** The thermistor connection is on pin 3. This allows the battery temperature to be monitored using a 10k NTC thermistor, which should be placed as close as possible to the battery cell. If no thermistor is used then this input should be connected directly to ground. The charger will operate when there is less than 315 $\Omega$  on this input (i.e., no thermistor connected); will be disabled when there is between 315 $\Omega$  and 3.94k $\Omega$ ; enabled when between 3.94k $\Omega$  and 28.3k $\Omega$ ; and disabled above 28.3k $\Omega$ .





### Functional Description (Cont.)

**CT** The Charge Timer input on pin 5 allows selection of how long the system timers for Prequal, Charge and Top-off states last. They are set by selecting the value of capacitor,  $C_{CT}$ :

$$\mathsf{TCHARGE} = 334\,\mathsf{min} \times \left(\frac{\mathsf{CCT}}{68\mathsf{nF}}\right)$$

$$\mathsf{TPREQUAL} = \mathsf{TTOPOFF} = 34.8\mathsf{min} \times \left(\frac{\mathsf{CCT}}{\mathsf{68nF}}\right)$$

The charge timer will hold its current value if the charging was stopped via the thermistor and continue when the battery is in a valid temperature range for charging.

#### OUTPUTS

**BAT** Pin 1 is the current-controlled charging output for the battery cell. It should be connected to the positive terminal of the battery. The chip monitors the voltage on this pin. There should be a  $2.2\mu$ F capacitor connected from BAT to GND.

**POK** The POK flag on pin 10 is pulled low when a valid power input is available on DC. It will go high when no valid power is available and the device will enter the Disable state.

**CHG** The CHG flag at pin 11 is pulled low when the device is in the Charge state. It will be high in Prequal and Top-off states. If the thermistor trips the circuit into the THM state (from Prequal or Charge states), CHG will hold its previous value.

**FLT** The FLT flag on pin 14 indicates a battery fault, as determined by a time-out in either the Prequal or Charge states. If the battery voltage does not reach 3V after the prequal timer (default 34.8mins), or does not reduce charging current to 7.5% <u>after</u> the charge timer (default 334mins), this indicates that the battery has failed or is failing and this <u>will</u> trigger the FLT flag. This flag will not automatically reset, and can only be cleared by cycling the power input or the EN pin.

APM8600 Document number: DS35140 Rev. 2 - 3



### **Functional Description (Cont.)**



The charging process is as follows, working through the state diagram.

The device will begin in the **Disable** state as the input power supply ramps from 0V. Once the input power supply has got into the valid range (4.15V - 7V), and the device is enabled then it will enter the **Prequal** state. This state allows for slow charging of a severely discharged battery. If the battery is already partially charged then the condition to move into the **Charge** state is met. If it is not then the slow charge will increase the battery voltage until it can enter the **Charge** state, or if the voltage does not rise sufficiently before the charge timer runs out (set using the capacitor on the CT pin) then the device will go into the **Fault** state, indicating that the battery cell may be damaged or has failed and is not taking charge. In the **Prequal** state the battery temperature can be monitored with a 10k NTC thermistor connected to the THM pin, and if the battery temperature goes out of range (above  $\sim$ 50°C or below  $\sim$ 0°C, depending on thermistor choice) then charging will be suspended with the device going into the **THM** state.

Once the battery has charged to a level of 3V, the device enters the **Charge** state, allowing faster charging of the battery in its normal voltage range, with 10 times the current used in the **Prequal** state. For information on setting the charge currents, see the functional description of the SETI pin. Again, the battery temperature is monitored and charging will be suspended if the temperature goes out of range. The **Charge** state will last until the current drawn by the battery drops to 7.5% of the full charge current. The device will then enter the **Top-Off** state, maintaining battery voltage and providing top-off charging current for the time defined by the  $C_T$  value. Once that timer completes, the device will enter the **Done** state, with zero battery current. If the battery voltage falls below 4.05V then the device will automatically return to the **Charge** state.



## **Ordering Information**



Destas	Package	Packaging	7" Tap	be and Reel
Device	Code	(Note 8)	Quantity	Part Number Suffix
APM8600FB-7	FB	U-DFN3030-14	3000/Tape & Reel	-7
Note: 8. Pad layout as a http://www.dioc	shown on Diodes les.com/package-	Inc. suggested pad layout outlines.html.	document, which can be found on our web	osite at
Marking Informa	ation			
		( Top V XX Y V •	<u>XX</u> : P4 : APM8600 <u>Y</u> : Year : 0~9 W: Week : A~7 : 1	eek; 52 and 53
Part N	lumber		Package	Identification Code
APM86	600FB-7		U-DFN3030-14	P3
	R (			



### Package Outline Dimensions (All Dimensions in mm)

## U-DFN3030-14





### **Taping Orientation (Note 9)**





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